

HYPER-MINIATURE LEVER & ROCKER SWITCHES

■ FEATURES

- It is of ultra-compact type. The volumetric ratio is half that of the conventional series A.
- Immersion cleaning is possible after soldering.
- Terminal mounting is at 0.1-inch pitches.
- Independent detent mechanism provides light feel operability.
- Regarding the contact reliability, a long-term stability is assured by the clip contact.
- Gold-plated contacts make these switches ideal for use with extremely small current.
- All plastic construction prevents a malfunction due to static electricity.

RoHS compliant

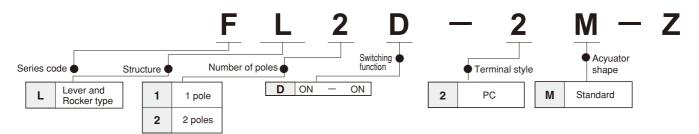
■ SPECIFICATIONS

	I		
Rating	Max: 0.4VA (28VDC max.) Min: 1 μA 20mVDC		
Initial contact resistance	100mΩmax. (1.5m	A 200 μVAC)	
Dielectric strength	250VAC 1 minute		
Insulation resistance	500M Ω min	(250VDC)	
Electrical life	10,000 cycles at max. rating 50,000 cycles at min. rating (D type)		
Operating temperature range	-40~+85℃		
Storage temperature range	-40~+85°C		

■ TABLE OF PART NUMBES

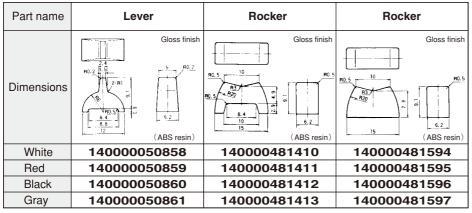
Number of poles	Terminal style	Switching function	Part No.
1 pole	PC terminal	ON - ON	FL1D-2M-Z
2 poles	PC terminal	ON - ON	FL2D-2M-Z

■ PART NUMBERING



■ STANDARD ACCESSORIES

■ LEVER - ROCKER MOUNTING



Lever	Rocker
6.2 5 5 0 0 0 0 0 0 0 0	15 6.2

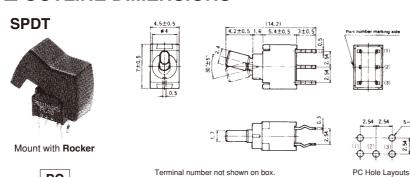
 Lever/Rocker is a standard accessory. Please choose one of them by specifying the part number.

- *Please contact us if you can't find your preferable combination in the table of part numbers.
- Specifications are subject to change without notice. Specifications in this catalog are for reference. The formal specification sheets will be submitted upon request.

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■ OUTLINE DIMENSIONS



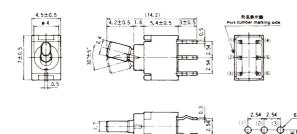
Switching function	Viewed from part No. marking side		
Part No.			47
FL1D-2M-Z	ON	_	ON
Connecting terminals	2-1	_	2-3





PC

PC



Terminal number not shown on box

Switching function	Viewed from part No. marking side		
Part No.		上戶	1
FL2D-2M-Z	ON	_	ON
Connecting terminals	2—1 5—4	_	2-3 5-6

■ SOLDERING

(1) Hand soldering
Device: Solder iron
380°C Max. 3 sec. Max.

(2) Auto soldering

Device: Wave or dip type 275°C Max. 6 sec. Max.

Preheat should be within 80-120 $^{\circ}\!\text{C}$ and less than 120 sec.

(3) When soldering two or more terminals to the common land, use solder resist to solder them independently.

■ FLUX CLEANING

PC Hole Layouts

(1) Solvents: Fluorine or Alcohol type

- (2) Cleaning shall be made when terminal temperature falls to 90°C or lower. Or, leave the switch at normal temperature for 5 minutes or longer, before cleaning.
- (3) Do not apply ultrasonic cleaning.

■ PACKAGING SPECIFICATION

